TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSV)

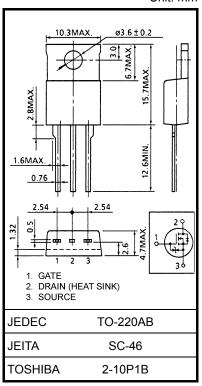
2SK2542

Switching Regulator Applications

- 4-V gate drive
- Low drain-source ON-resistance $: R_{DS} (ON) = 0.75 \Omega (typ.)$
- High forward transfer admittance $|Y_{fs}| = 7.0 \text{ S (typ.)}$
- Low leakage current : $IDSS = 100 \mu A (max) (VDS = 500 V)$
- Enhancement mode : $V_{th} = 2.0$ to 4.0 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	500	V	
Drain-gate voltage (R	_{GS} = 20 kΩ)	V _{DGR}	500	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	۱ _D	8	А	
	Pulse (Note 1)	I _{DP}	32	А	
Drain power dissipation	n (Tc = 25°C)	PD	80	W	
Single pulse avalanche	e energy (Note 2)	E _{AS}	312	mJ	
Avalanche current		I _{AR}	8	А	
Repetitive avalanche e	nergy (Note 3)	E _{AR}	8	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature ra	ange	T _{stg}	-55 to 150	°C	



Weight: 2.0 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	1.56	°C / W
Thermal resistance, channel to ambient	R _{th (ch−a)}	83.3	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 8.3 mH, R_G = 25 Ω , I_{AR} = 8 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution. Unit: mm

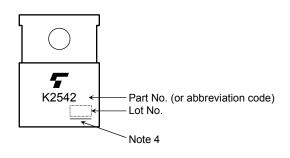
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V_{GS} = ±25 V, V_{DS} = 0 V	_	_	±10	μA
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V_{DS} = 500 V, V_{GS} = 0 V		_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	500	_		V
Gate threshold v	/oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0		4.0	V
Drain-source O	N-resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 4 A		0.75	0.85	Ω
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 4 A	3.5	7.0	_	S
Input capacitance	e	C _{iss}			1300	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		130	_	pF
Output capacitance		C _{oss}			400		
Switching time	Rise time	tr	$V_{GS} \stackrel{10 \text{ V}}{}_{0 \text{ V}} \int I_{D} = 4 \text{ A}$ $V_{GS} \stackrel{0 \text{ V}}{}_{0 \text{ V}} \int I_{D} = 4 \text{ A}$ R_{L} $= 50 \Omega$ $V_{DD} = 200 \text{ V}$	_	26		- ns
	Turn-on time	t _{on}		_	45		
	Fall time	t _f			40		
	Turn-off time	t _{off}	Duty $\leq 1\%$, t _w = 10 µs	_	140	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	30	-	
Gate-source charge		Q _{gs}	V _{DD} ≈ 400 V, V _{GS} = 10 V, I _D = 8 A		17		nC
Gate-drain ("miller") charge		Q _{gd}			13	—	

Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_	_	8	А
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	32	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 8 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 8 A, V _{GS} = 0 V		1200		ns
Reverse recovery charge	Q _{rr}	dI _{DR} / dt = 100 A / µs		10		μC

Marking

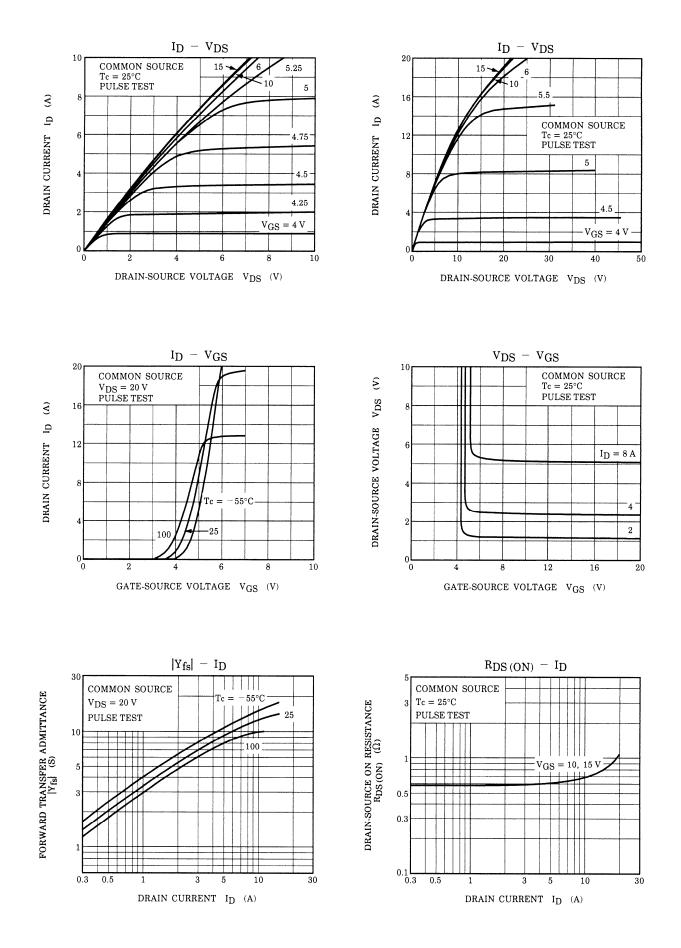


Note 4: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV

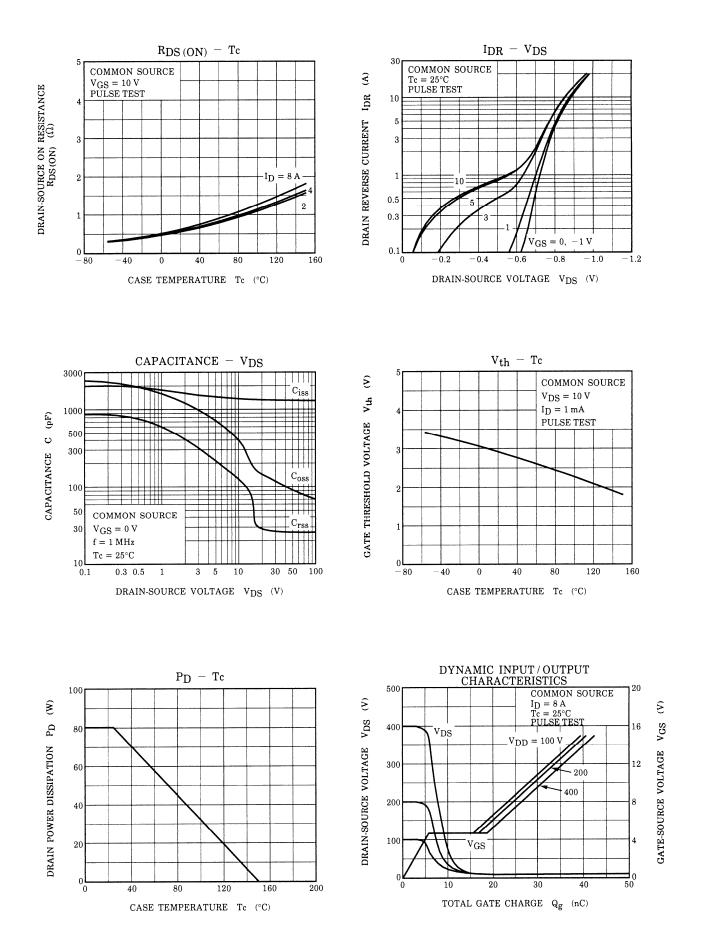
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

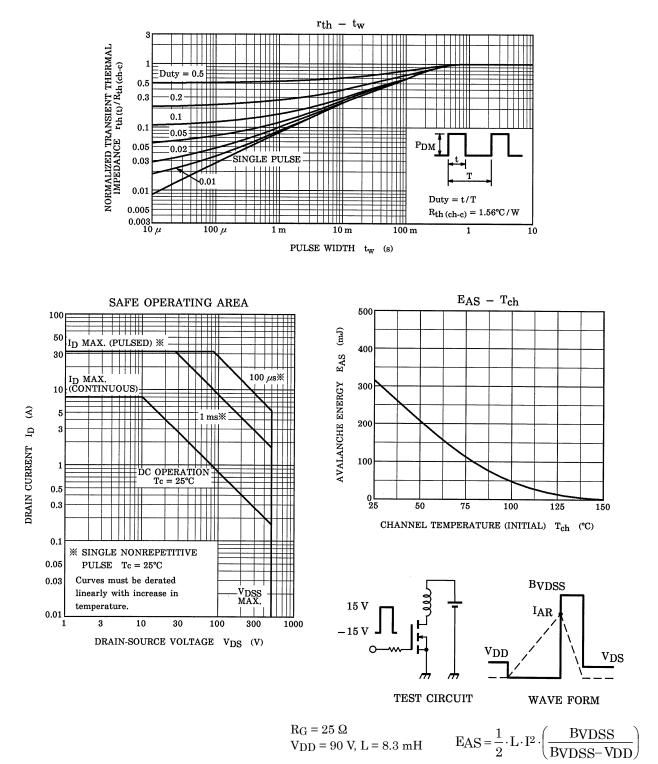
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